



ELECTRONIC INFORMATION DISCLOSURE STATEMENT

Electronic Version v18

Stylesheet Version v18.0

| Title of Invention | ARTICLES COMPRISING SUPERABSORBENT MATERIALS HAVING A BIMODAL PARTICLE SIZE DISTRIBUTION | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
|--|--|------------|------------|---------------|------|-------|----------|-------------------------|----------|------------|------|----------|------|-------|----------|--|---|---------|------------|-------------|--|--|--|--|---|---------|------------|--------------|--|--|--|--|---|---------|------------|--------------|--|--|--|--|---|---------|------------|-----|--|--|--|
| Application Number: | 09/974638 | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| Confirmation Number: | 9958 | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| First Named Applicant: | Michael Niemeyer et al. | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| Attorney Docket Number: | 13967C | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| Art Unit: | 3761 | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| Search string: | (5800419 or 5713881 or 5466513 or 5419956).pn. | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| RECEIVED SEP 05 2003 TECHNOLOGY CENTER R3700 | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| US Patent Documents | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| Note: Applicant is not required to submit a paper copy of cited US Patent Documents | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| <table border="1"><thead><tr><th>init</th><th>Cite.No.</th><th>Patent No.</th><th>Date</th><th>Patentee</th><th>Kind</th><th>Class</th><th>Subclass</th></tr></thead><tbody><tr><td></td><td>1</td><td>5800419</td><td>1998-09-01</td><td>Soga et al.</td><td></td><td></td><td></td></tr><tr><td></td><td>2</td><td>5713881</td><td>1998-02-03</td><td>Rezai et al.</td><td></td><td></td><td></td></tr><tr><td></td><td>3</td><td>5466513</td><td>1995-11-14</td><td>Wanek et al.</td><td></td><td></td><td></td></tr><tr><td></td><td>4</td><td>5419956</td><td>1995-05-30</td><td>Roe</td><td></td><td></td><td></td></tr></tbody></table> | | | | | | | | init | Cite.No. | Patent No. | Date | Patentee | Kind | Class | Subclass | | 1 | 5800419 | 1998-09-01 | Soga et al. | | | | | 2 | 5713881 | 1998-02-03 | Rezai et al. | | | | | 3 | 5466513 | 1995-11-14 | Wanek et al. | | | | | 4 | 5419956 | 1995-05-30 | Roe | | | |
| init | Cite.No. | Patent No. | Date | Patentee | Kind | Class | Subclass | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| | 1 | 5800419 | 1998-09-01 | Soga et al. | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| | 2 | 5713881 | 1998-02-03 | Rezai et al. | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| | 3 | 5466513 | 1995-11-14 | Wanek et al. | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| | 4 | 5419956 | 1995-05-30 | Roe | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| RECEIVED SEP 10 2003 TECH CENTER 1600/2900 | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| Remarks | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| Note: Remarks are not for responding to an office action. | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609. Draw line through citation if not in conformance and not considered. Include a copy of this form with your next communication. | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| RECEIVED OCT 01 2003 | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| Signature | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| <table border="1"><tr><td>Examiner Name</td><td>Date</td></tr><tr><td></td><td></td></tr></table> | | | | Examiner Name | Date | | | TECHNOLOGY CENTER R3700 | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| Examiner Name | Date | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |